## COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

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My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

## STACK-TYPE MULTI-CHIP PACKAGE AND METHOD OF FABRICATING BUMPS ON THE BACKSIDE OF A CHIP

the specification of whi						
<ul><li>X is attached hereto</li><li>was filed on</li></ul>						
		and was amended on	and was amended on			
specification, including I acknowledge the application in accordan I hereby claim fore application(s) for pater	the claims, as amended the claims, as amended to disclose inforce with Title 37, Code of the control of the con	nd understand the conte by any amendment referr mation which is material f Federal Regulations, § der Title 35, United States te listed below and have icate having a filing date b	red to above. to the paten 1.56(a). Code, § 119 e also identif	tability of this of any foreign		
Number	Country	Date Filed(yyyy/mm/dd)	Yes	No		
92109018	Taiwan, R.O.C.	2003/4/18	X			
I hereby appoint the transact all business in t	ne following attorney(s) he Patent and Tradema	and/or agent(s) to prosective connected therever	cute this application	lication and to		
Belinda Lee Jiawei Huang Charles C.H. Wu	(Reg. No. 46,863) (Reg. No. 43,330) (Reg. No. 39,081)		(Reg. No. 53,226)			
SEND CORRESPONDENCE TO:		DIRECT TELEPHONE CALLS TO: (Name and telephone number)				
JIANQ CHYUN Intellectual Property Office 7F1, No. 100, Roosevelt Rd., Sec. 2, Taipei 100, Taiwan, R.O.C.		e <b>Belind</b>	a Lee			

## COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Signature:	Chih - Hung	Chang	Date:	July 14. 200)	
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